

Taiwan-Asia Semiconductor Corporation 2026 Investor Conference

Sensing the Future.
Powering the Next.

2026.10.14



FORWARD-LOOKING STATEMENTS

This presentation may contain forward-looking statements. These statements are based on current expectations and are subject to known and unknown risks and uncertainties, which may cause actual results to differ materially from those expressed or implied.

Except as required by law, the Company undertakes no obligation to update or revise any forward-looking statements in light of new information or future events.

Investors should exercise their own judgment based on public information and risk assessments.

AGENDA



*Stabilizing Core Business, Introducing New Materials, Accelerating Productization,
And Building The Next Growth Curve.*

01 GROUP OVERVIEW & FINANCIAL PERFORMANCE

2026 Revenue Growth
and Product Mix

02 STRATEGY & OUTLOOK

Future Technology Roadmap
and Commercialization

03 HUSD R&D PROGRESS & PLAN

R&D Overview
and Market Planning

From Sensing to Intelligence.

GROUP OVERVIEW / FINANCIAL PERFORMANCE

GROUP OVERVIEW

FROM A SINGLE OPTOELECTRONIC COMPONENT TO A DIVERSIFIED TECHNOLOGY GROUP



TASC | Taiwan-Asia Semiconductor Corporation

Parent company focusing on strategic deployment in sensing/emitting components and compound semiconductors.



SAVC | Star Asia Vision Corporation

Digital display systems, outdoor signage systems, and outdoor visual system integration.



NSTC | NEW SMART TECHNOLOGY CO.,LTD.

AOI equipment & AI smart automated inspection integration solutions.



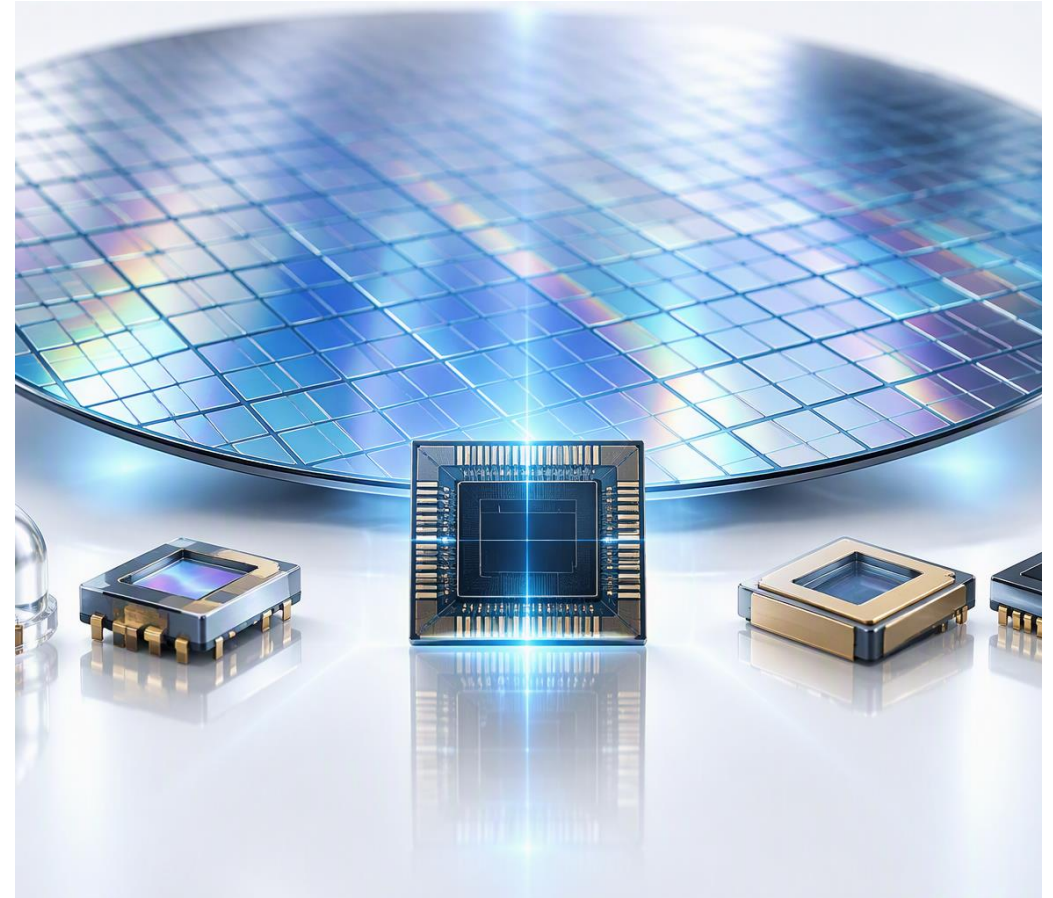
PASC | ProAsia Semiconductor Corporation

SiC power component chip R&D and wafer manufacturing (6-inch wafer production line).



CASC | Champ-Asia Semiconductor Corporation

GaN power components and high-voltage, high-frequency semiconductor product design and R&D.



SUSTAINED REVENUE GROWTH EXPANDING TOWARD A DIVERSIFIED PORTFOLIO

2026 H1 Total Revenue

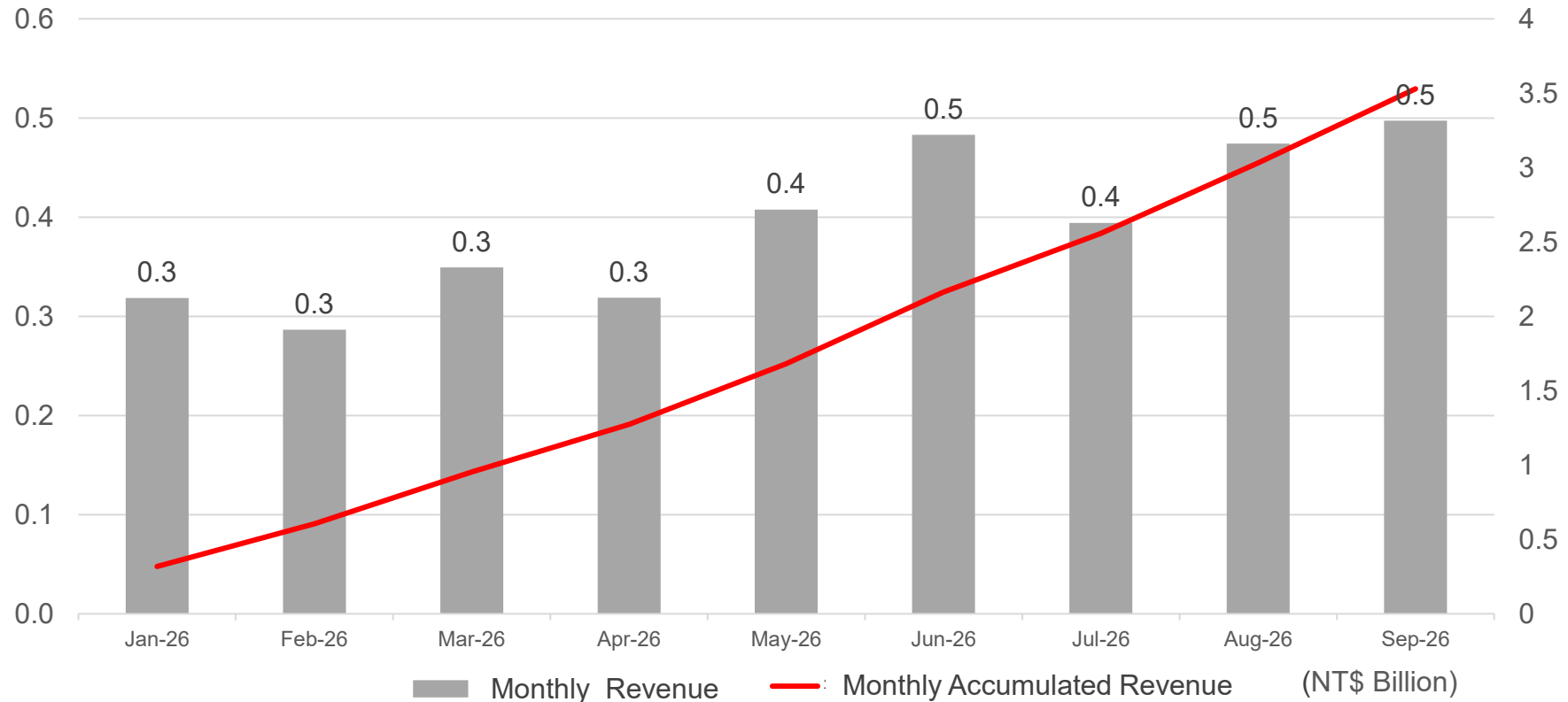
YoY

NT\$2.16 billion **+2.2%**

2026 Jan–Sep Consolidated Revenue

YoY

NT\$3.5 billion **+8.16%**



STRATEGY & FUTURE OUTLOOK

STRATEGY: CORE STABILIZATION & NEW VENTURE GROWTH

CURRENT ENGINE

Consolidating Core Business

Sensing & Emitting components

System business & Display applications

Manufacturing capabilities
& Customer base



NEXT ENGINE

Creating Future Growth

SWIR / eSWIR

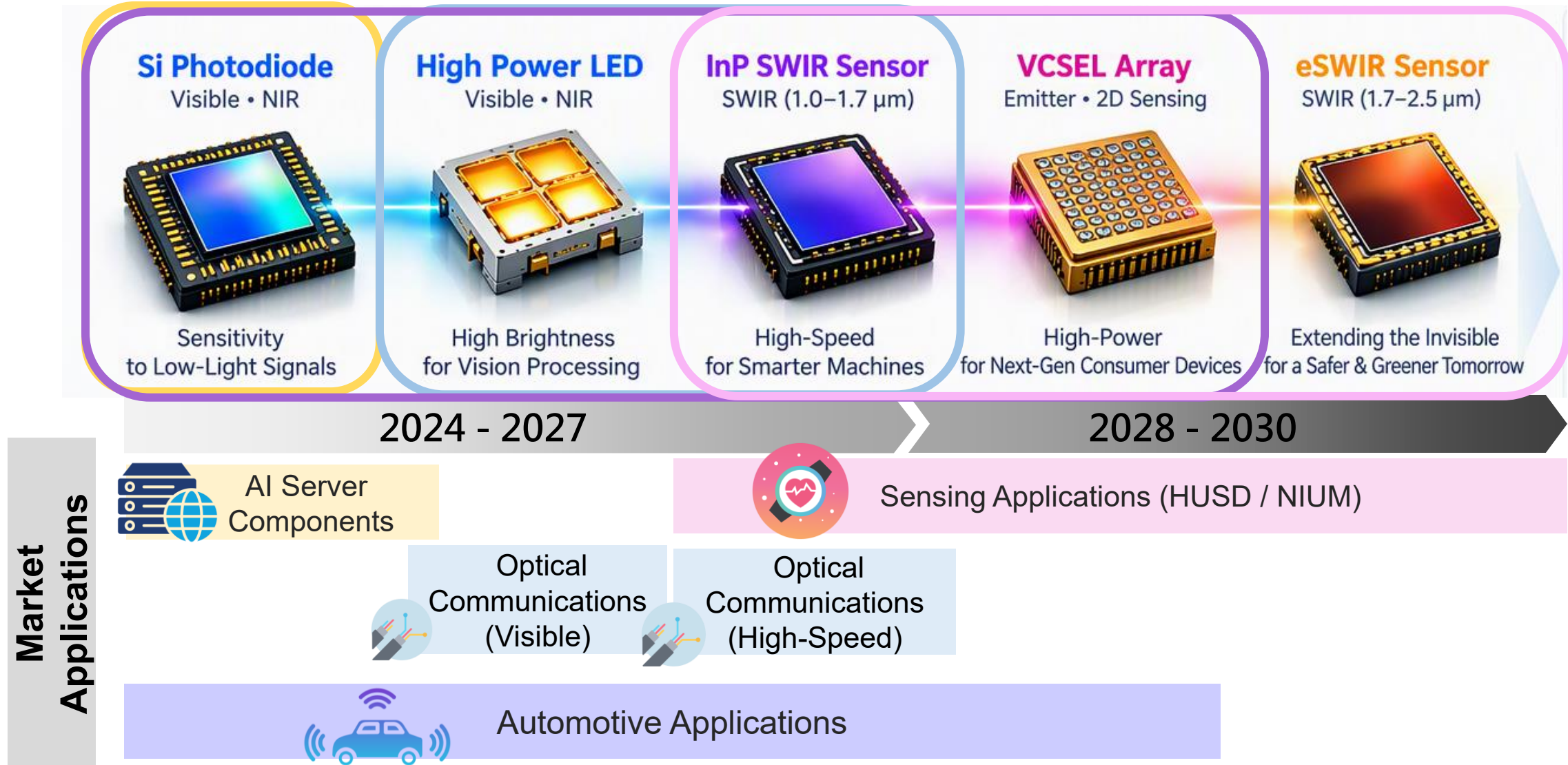
HUSD health sensing

AI Vision / AOI

SiC / GaN power components

Building the next growth curve leveraging core technologies, manufacturing, and customer base.

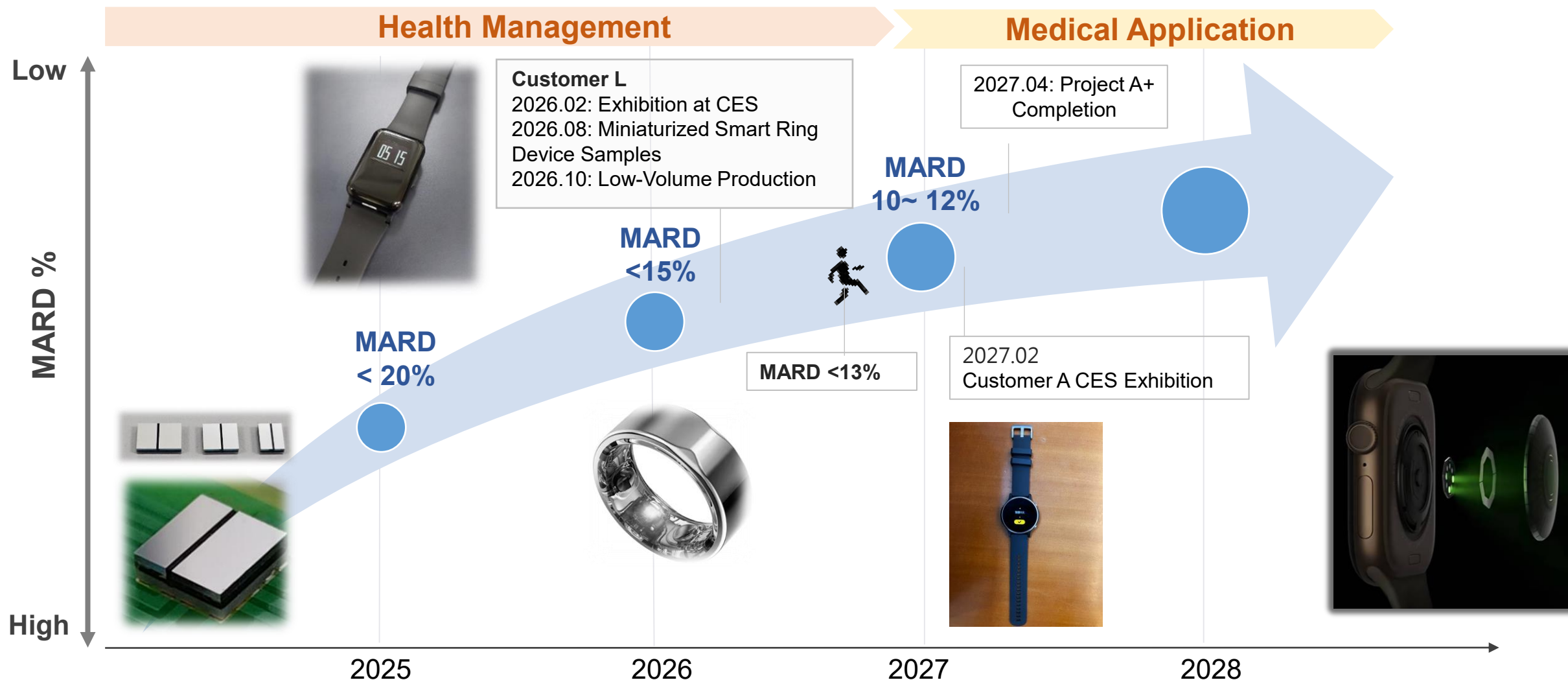
TASC TECHNOLOGY DEVELOPMENT ROADMAP & MARKET APPLICATIONS



HUSD (NICGM) R&D PROGRESS & PLAN

HUSD R&D MILESTONES

2026 Continuous Accuracy Enhancement → Target 2027 MARD <12%



VERTICAL INTEGRATION: COMPONENTS, MODULES, AND ALGORITHMS

01 Optical Chip

Multi-wavelength light sources and sensing

02 Sensor Module

Miniaturization and optical path integration

03 Firmware + ML

Feature extraction and trend algorithms

04 Health Application

Wearables, health management, medical partnerships



FIVE COMMITMENTS

INTEGRATING TASC SPIRIT INTO INVESTOR COMMITMENTS

Learning, Thinking, Working, Creating the Best Products in the World

01 Customer Service	Quality, Reliability, and Response Speed	Stable Revenue and Stickiness
02 Operational Efficiency	Optimizing Process Capabilities, Yield, and Costs	Improving Gross Margin
03 In-House Development	Epitaxy, Chips, Algorithms, and Modules	Strengthening Technology Barriers
04 Product Innovation	New Product and Application Development	Expanding Total Addressable Market
05 Diversification	GaN / SiC / SWIR / HUSD / NIUM	Building New Growth Curves



WE BUILD WHAT THE FUTURE NEEDS.

By sensing to see demands,
by technology to create the next growth.

FOCUS

EXECUTE

SCALE